## TDA7210V

ASK/FSK Single Conversion Receiver

## Data Sheet

Revision 1.1, 2010-06-18

## Wireless Sense \& Control

## Edition 2010-06-18

Published by
Infineon Technologies AG
81726 Munich, Germany
© 2010 Infineon Technologies AG

## All Rights Reserved.

## Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

## Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

## Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.
Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

## TDA7210V ASK/FSK Single Conversion Receiver

Revision History: 2010-06-18, Revision 1.1
Previous Revision: 1.0

| Page | Subjects (major changes since last revision) |
| :--- | :--- |
| 29 | Explanation regarding the Absolute Maximum Ratings |
|  |  |
|  |  |
|  |  |

## Trademarks of Infineon Technologies AG

A-GOLD ${ }^{\text {TM }}$, BlueMoon ${ }^{\text {TM }}$, COMNEON ${ }^{\text {TM }}$, CONVERGATE ${ }^{\text {TM }}$, COSIC ${ }^{\text {TM }}$, C166 ${ }^{\text {TM }}$, CROSSAVE ${ }^{T M}$, CanPAK ${ }^{\text {TM }}$, CIPOS $^{\text {TM }}$, CoolMOS ${ }^{\text {TM }}$, CooISET ${ }^{\text {TM }}$, CONVERPATH ${ }^{\text {TM }}$, CORECONTROL ${ }^{\text {TM }}$, DAVE ${ }^{\text {TM }}$, DUALFALC ${ }^{\text {TM }}$, DUSLIC ${ }^{\text {TM }}$, EasyPIM ${ }^{\text {TM }}$, EconoBRIDGE ${ }^{\text {TM }}$, EconoDUAL ${ }^{\text {TM }}$, EconoPACK ${ }^{\text {TM }}$, EconoPIM ${ }^{\text {TM }}$, E-GOLD ${ }^{\text {TM }}$, EiceDRIVER ${ }^{\text {™ }}$,
 HybridPACK ${ }^{\text {TM }}$, INCA ${ }^{\text {TM }}$, ISAC ${ }^{T M}$, ISOFACE ${ }^{\text {TM }}$, IsoPACK ${ }^{\text {TM }}$, IWORX ${ }^{\text {TM }}$, M-GOLD ${ }^{\text {TM }}$, MIPAQ ${ }^{\text {TM }}$, ModSTACK ${ }^{\text {TM }}$, MUSLIC ${ }^{\text {TM }}$, my-d ${ }^{\text {TM }}$, NovalithIC ${ }^{T M}$, OCTALFALC ${ }^{\text {TM }}$, OCTAT ${ }^{T M}$, OmniTune ${ }^{\text {TM }}$, OmniVia ${ }^{\text {TM }}$, OptiMOS ${ }^{\text {TM }}$, OPTIVERSE ${ }^{\text {TM }}$, ORIGA ${ }^{\text {TM }}$, PROFET ${ }^{\text {TM }}$, PRO-SIL ${ }^{T M}$, PrimePACK ${ }^{T M}$, QUADFALC ${ }^{T M}$, RASIC ${ }^{T M}$, ReverSave ${ }^{\text {TM }}$, SatRIC ${ }^{\text {TM }}$, SCEPTRE ${ }^{\text {TM }}$, SCOUT ${ }^{\text {TM }}$, S-GOLD ${ }^{\text {TM }}$, SensoNor ${ }^{\text {TM }}$, SEROCCO ${ }^{\text {TM }}$, SICOFI ${ }^{\text {TM }}$, SIEGET ${ }^{\text {TM }}$, SINDRION ${ }^{\text {TM }}$, SLIC $^{\text {TM }}$, SMARTi ${ }^{T M}$, SmartLEWIS ${ }^{\text {TM }}$, SMINT ${ }^{\text {TM }}$, SOCRATES ${ }^{\text {TM }}$, TEMPFET $^{T M}$, thinQ! ${ }^{\text {TM }}$, TrueNTRY ${ }^{\text {TM }}$, TriCore $^{\text {TM }}$, TRENCHSTOP ${ }^{\text {TM }}$, VINAX ${ }^{\text {TM }}$, VINETIC ${ }^{\text {TM }}$, VIONTIC ${ }^{\text {TM }}$, WildPass $^{\text {TM }}$, X-GOLD ${ }^{\text {TM }}$, XMM $^{\text {TM }}$, X-PMU ${ }^{\text {™ }}$, XPOSYS $^{\text {™ }}$, XWAY $^{\text {™ }}$.

## Other Trademarks

AMBA $^{\text {TM }}$, ARM $^{\text {TM }}$, MULTI-ICE ${ }^{\text {TM }}$, PRIMECELL ${ }^{\text {TM }}$, REALVIEW ${ }^{\text {TM }}$, THUMB ${ }^{\text {TM }}$ of ARM Limited, UK. AUTOSAR ${ }^{\text {TM }}$ is licensed by AUTOSAR development partnership. Bluetooth ${ }^{\text {TM }}$ of Bluetooth SIG Inc. CAT-iq ${ }^{\text {TM }}$ of DECT Forum. COLOSSUS ${ }^{T M}$, FirstGPS ${ }^{T M}$ of Trimble Navigation Ltd. EMV ${ }^{\text {TM }}$ of EMVCo, LLC (Visa Holdings Inc.). EPCOS ${ }^{\text {TM }}$ of Epcos AG. FLEXGO ${ }^{\text {TM }}$ of Microsoft Corporation. FlexRay ${ }^{\text {TM }}$ is licensed by FlexRay Consortium. HYPERTERMINAL ${ }^{\text {TM }}$ of Hilgraeve Incorporated. IEC ${ }^{\text {TM }}$ of Commission Electrotechnique Internationale. IrDA ${ }^{\text {TM }}$ of Infrared Data Association Corporation. ISO ${ }^{\text {TM }}$ of INTERNATIONAL ORGANIZATION FOR STANDARDIZATION. MATLAB ${ }^{\text {TM }}$ of MathWorks, Inc. MAXIM ${ }^{\text {TM }}$ of Maxim Integrated Products, Inc. MICROTEC ${ }^{\text {TM }}$, NUCLEUS ${ }^{\text {TM }}$ of Mentor Graphics Corporation. Mifare ${ }^{\text {TM }}$ of NXP. MIPI ${ }^{\text {TM }}$ of MIPI Alliance, Inc. MIPS ${ }^{\text {TM }}$ of MIPS Technologies, Inc., USA. muRata ${ }^{\text {TM }}$ of MURATA MANUFACTURING CO. OmniVision ${ }^{\text {TM }}$ of OmniVision Technologies, Inc. Openwave ${ }^{\text {TM }}$ Openwave Systems Inc. RED HAT ${ }^{\text {TM }}$ Red Hat, Inc. RFMD ${ }^{\text {TM }}$ RF Micro Devices, Inc. SIRIUS ${ }^{\text {TM }}$ of Sirius Sattelite Radio Inc. SOLARIS ${ }^{\text {TM }}$ of Sun Microsystems, Inc. SPANSION ${ }^{\text {TM }}$ of Spansion LLC Ltd. Symbian ${ }^{\text {TM }}$ of Symbian Software Limited. TAIYO YUDEN ${ }^{\text {TM }}$ of Taiyo Yuden Co. TEAKLITE ${ }^{\text {TM }}$ of CEVA, Inc. TEKTRONIX ${ }^{\text {™ }}$ of Tektronix Inc. TOKO ${ }^{\text {TM }}$ of TOKO KABUSHIKI KAISHA TA. UNIX ${ }^{\text {TM }}$ of X/Open Company Limited. VERILOG ${ }^{\text {TM }}$, PALLADIUM ${ }^{\text {TM }}$ of Cadence Design Systems, Inc. VLYNQ ${ }^{\text {TM }}$ of Texas Instruments Incorporated. VXWORKS ${ }^{\text {TM }}$, WIND RIVER ${ }^{\text {TM }}$ of WIND RIVER SYSTEMS, INC. ZETEX ${ }^{\text {TM }}$ of Diodes Zetex Limited.
Last Trademarks Update 2009-10-19

## Table of Contents

## Table of Contents

Table of Contents ..... 4
1 Product Description ..... 5
1.1 Overview ..... 5
1.2 Features ..... 5
1.3 Application ..... 5
1.4 Ordering Information ..... 6
1.5 Package Outlines ..... 6
2 Functional Description ..... 7
2.1 Pin Configuration ..... 7
2.2 Pin Definition and Function ..... 8
2.3 Functional Block Diagram ..... 13
2.4 Functional Blocks ..... 13
2.4.1 Low Noise Amplifier (LNA) ..... 14
2.4.2 Mixer ..... 14
2.4.3 PLL Synthesizer ..... 14
2.4.4 Crystal Oscillator ..... 14
2.4.5 Limiter ..... 15
2.4.6 FSK Demodulator ..... 15
2.4.7 Data Filter ..... 15
2.4.8 Data Slicer ..... 16
2.4.9 Peak Detector ..... 16
2.4.10 Bandgap Reference Circuitry ..... 16
3 Applications ..... 17
3.1 Choice of LNA Threshold Voltage and Time Constant ..... 17
3.2 Data Filter Design ..... 19
3.3 Quartz Load Capacitance Calculation ..... 20
3.4 Quartz Frequency Calculation ..... 21
3.5 Data Slicer Threshold Generation ..... 22
3.6 ASK/FSK Switch Functional Description ..... 23
3.6.1 FSK Mode ..... 23
3.6.2 ASK Mode ..... 25
3.7 Principle of the Precharge Circuit ..... 25
4 Electrical Characteristics ..... 29
4.1 Electrical Data ..... 29
4.1.1 Absolute Maximum Ratings ..... 29
4.1.2 Operating Range ..... 29
4.1.3 $\quad$ AC/DC Characteristics at $\mathrm{T}_{\mathrm{AMB}}=25^{\circ} \mathrm{C}$ ..... 31
4.1.4 $\quad$ AC/DC Characteristics at $\mathrm{T}_{\mathrm{AMB}}=-40$ to $85^{\circ} \mathrm{C}$ ..... 36
4.2 Customer Test Circuit ..... 38
4.3 Customer Test Board Layout ..... 40
4.4 Bill of Materials ..... 42

## 1 Product Description

### 1.1 Overview

The IC is a very low power consumption single chip FSK/ASK Superheterodyne Receiver (SHR) for the frequency bands 810 to 870 MHz and 400 to 440 MHz . The IC offers a high level of integration and needs only a few external components. The device contains a low noise amplifier (LNA), a double balanced mixer, a fully integrated VCO, a PLL synthesiser, a crystal oscillator, a limiter with RSSI generator, a PLL FSK demodulator, a data filter, a data comparator (slicer) and a peak detector. Additionally there is a power down feature to save battery life.

### 1.2 Features

Main features:

- Selectable frequency ranges $810-870 \mathrm{MHz}$ and $400-440 \mathrm{MHz}$
- Low supply current (at 434 MHz Is $=5.7 \mathrm{~mA}$ typ. FSK mode, 5.0 mA typ. ASK mode)
- Power down mode with very low supply current ( 50 nA typ.)
- FSK and ASK demodulation capability
- RF input sensitivity ASK/FSK typ. $-115 \mathrm{dBm} /-112 \mathrm{dBm} @ 1 \mathrm{kbit} / \mathrm{s}$ RF=434 MHz
- RF input sensitivity ASK/FSK typ. $-111 \mathrm{dBm} /-111 \mathrm{dBm} @ 1 \mathrm{kbit} / \mathrm{s}$ RF=868 MHz
- Fully integrated VCO and PLL Synthesiser
- Limiter with RSSI generation, operating at 10.7 MHz
- Selectable reference frequency
- 2nd order low pass data filter with external capacitors
- Data slicer with self-adjusting threshold
- Supply voltage range $5 \mathrm{~V} \pm 10 \%$


### 1.3 Application

The TDA7210V is suitable for any kind of remote control system especially for low data rate wireless applications where low current consumption is important and where the line-of-sight limitation is driving the infra-red to RF replacement.
Main applications:

- Home automation
- Lighting Control
- Curtain, Roller Blind Control
- Air Condition Control
- Set-top-boxes
- Garage Door Openers
- Alarm Systems
- Wireless Toys
- Remote Keyless Entry Systems


### 1.4 Ordering Information

Table 1 Ordering Info

| Type | Ordering Code | Package $^{\text {1) }}$ |
| :--- | :--- | :--- |
| TDA7210V | SP000698080 | VQFN-32 |
| 1) Samples available on tape and reel. |  |  |

### 1.5 Package Outlines



Figure 1 Package


Figure 2 VQFN-32 Package Outlines

## 2 Functional Description

### 2.1 Pin Configuration



Figure 3 Pin Configuration TDA7210V

### 2.2 Pin Definition and Function

In the subsequent table the internal circuits connected to the pins of the device are shown. ESD-protection circuits are omitted to ease reading.

Table 2 Pin Definition and Function

| Pin No. | Symbol | Equivalent I/O-Schematic | Function |
| :---: | :---: | :---: | :---: |
| 1 | LNI |  | LNA Input |
| 2 | TAGC |  | AGC Time Constant Control |
| 3 | AGND1 |  | Analogue Ground Return |
| 4 | LNO |  | LNA Output |

Table 2 Pin Definition and Function (cont'd)

| Pin No. | Symbol | Equivalent I/O-Schematic | Function |
| :---: | :---: | :---: | :---: |
| 5 | VCC1 |  | 5 V Supply |
| 6 | MI |  | Mixer Input |
| 7 | MIX |  | Complementary Mixer Input |
| 8 | AGND2 |  | Analogue Ground Return |
| 9 | FSEL |  | 868/434 MHz Operating Frequency Selector |
| 10 | IFO |  | 10.7 MHz IF Mixer Output |
| 11 | GNDRF2 |  | Internal GND Plane connected to RF-GND |
| 12 | DGND |  | Digital Ground Return |
| 13 | VDD |  | 5 V Supply Digital |

Table 2 Pin Definition and Function (cont'd)

| Pin No. | Symbol | Equivalent I/O-Schematic | Function |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
| 14 | MSEL |  |  | ASK/FSK Modulation Format |
| Selector |  |  |  |  |

Table 2 Pin Definition and Function (cont'd)

| Pin No. | Symbol | Equivalent I/O-Schematic | Function |
| :---: | :---: | :---: | :---: |
| 19 | SLN |  | Data Slicer Negative Input |
| 20 | OPP |  | OpAmp Noninverting Input |
| 21 | GNDRF3 |  | Internal GND Plane connected to RF-GND |
| 22 | FFB |  | Data Filter Feedback Pin |
| 23 | THRES |  | AGC Threshold Input |
| 24 | 3VOUT |  | 3 V Reference Output |

Table 2 Pin Definition and Function (cont'd)

| Pin No. | Symbol | Equivalent I/O-Schematic | Function |
| :---: | :---: | :---: | :---: |
| 25 | DATA |  | Data Output |
| 26 | PDO |  | Peak Detector Output |
| 27 | PDWN |  | Power Down Input |
| 28 | CRST2 |  | External Crystal Connector 2 |
| 29 | N.C. |  | Not connected |

Table 2 Pin Definition and Function (cont'd)

| Pin No. | Symbol | Equivalent I/O-Schematic | Function |  |
| :--- | :--- | :--- | :--- | :--- |
| 30 | CRST1 |  | External Crystal Connector 1 |  |
|  |  |  | 50 l |  |
|  |  |  |  |  |
| 31 | VCC2 |  |  | Internal GND Plane connected <br> to RF-GND |
| 32 | GNDRF1 |  |  |  |

### 2.3 Functional Block Diagram



Figure 4 Main Block Diagram TDA7210V

### 2.4 Functional Blocks

## Functional Description

### 2.4.1 Low Noise Amplifier (LNA)

The LNA is an on-chip cascode amplifier with a voltage gain of 20 to 27 dB (depending on the matching). The gain figure is determined by the external matching networks situated ahead of LNA and between the LNA output LNO (Pin 4) and the Mixer Inputs MI and MIX (Pins 6 and 7). The noise figure of the LNA is approximately 3 dB , the current consumption is $500 \mu \mathrm{~A}$. The gain can be reduced by approximately 18 dB . The switching point of this AGC action can be determined externally by applying a threshold voltage at the THRES pin (Pin 23). This voltage is compared internally with the received signal (RSSI) level generated by the limiter circuitry. In case that the RSSI level is higher than the threshold voltage the LNA gain is reduced and vice versa. The threshold voltage can be generated by attaching a voltage divider between the 3VOUT pin (Pin 24) which provides a temperature stable 3 V output generated from the internal bandgap voltage and the THRES pin as described in Chapter 3.1. The time constant of the AGC action can be determined by connecting a capacitor to the TAGC pin (Pin 2) and should be chosen along with the appropriate threshold voltage according to the intended operating case and interference scenario to be expected during operation. The optimum choice of AGC time constant and the threshold voltage is described in Chapter 3.1.

### 2.4.2 Mixer

The Double Balanced Mixer downconverts the input frequency (RF) in the range of $400-440 \mathrm{MHz} / 810-870 \mathrm{MHz}$ to the intermediate frequency (IF) at 10.7 MHz with a voltage gain of approximately 24 dB (depending on the matching) by utilising either high- or low-side injection of the local oscillator signal. In case the mixer is interfaced only single-ended, the unused mixer input has to be tied to ground via a capacitor. The mixer is followed by a low pass filter with a corner frequency of 20 MHz in order to suppress RF signals to appear at the IF output (IFO pin). The IF output is internally consisting of an emitter follower that has a source impedance of approximately $330 \Omega$ to facilitate interfacing the pin directly to a standard 10.7 MHz ceramic filter without additional matching circuitry.

### 2.4.3 PLL Synthesizer

The Phase Locked Loop synthesiser consists of a VCO, an asynchronous divider chain, a phase detector with charge pump and a loop filter and is fully implemented on-chip. The VCO is including on-chip spiral inductors and varactor diodes. It's nominal centre frequency is 840 MHz , the operating range guaranteed over the temperature range specified is 820 to 860 MHz . Depending on whether high- or low-side injection of the local oscillator is used the receive frequency ranges are 810 to 840 MHz and 840 to 870 MHz or 400 to 420 MHz and 420 to 440 MHz (see also Chapter 3.4). No additional external components are necessary.
The oscillator signal is fed both to the synthesiser divider chain and to the downconverting mixer. In case of operation in the 400 to 440 MHz range, the signal is divided by two before it is fed to the mixer. This is controlled by the selection pin FSEL (Pin 9) as described in the following table. The overall division ratio of the divider chain can be selected to be either 128 or 64 , depending on the frequency of the reference oscillator quartz (see below and Chapter 3.4). The loop filter is also realised fully on-chip.

Table 3 FSEL Pin Operating States

| FSEL | RF Frequency |
| :--- | :--- |
| Open | $400-440 \mathrm{MHz}$ |
| Shorted to ground | $810-870 \mathrm{MHz}$ |

### 2.4.4 Crystal Oscillator

The on-chip crystal oscillator circuitry allows for utilisation of quartzes both in the 6 and 13 MHz range as the overall division ratio of the PLL can be switched between 64 and 128 via the CSEL (Pin 15) pin according to the following table.

Table 4 CSEL Pin Operating States

| CSEL | Crystal Frequency |
| :--- | :--- |
| Open | $6 . x x \mathrm{MHz}$ |
| Shorted to ground | $13 . x x \mathrm{MHz}$ |

The calculation of the value of the necessary quartz load capacitance is shown in Chapter 3.3, the quartz frequency calculation is explained in Chapter 3.4.

### 2.4.5 Limiter

The Limiter is an AC coupled multistage amplifier with a cumulative gain of approximately 80 dB that has a bandpass-characteristic centred around 10.7 MHz . It has a typical input impedance of $330 \Omega$ to allow for easy interfacing to a 10.7 MHz ceramic IF filter. The limiter circuit also acts as a Receive Signal Strength Indicator (RSSI) generator which produces a DC voltage that is directly proportional to the input signal level as can be seen in Figure 6. This signal is used to demodulate ASK-modulated receive signals in the subsequent baseband circuitry. The RSSI output is applied to the modulation format switch, to the Peak Detector input and to the AGC circuitry.
In order to demodulate ASK signals the MSEL pin has to be left open as described in the next chapter.

### 2.4.6 FSK Demodulator

To demodulate frequency shift keyed (FSK) signals a PLL circuit is used that is contained fully on chip. The Limiter output differential signal is fed to the linear phase detector as is the output of the 10.7 MHz center frequency VCO. The demodulator gain is typically $200 \mu \mathrm{~V} / \mathrm{kHz}$. The passive loop filter output that is comprised fully on chip is fed to both the VCO and the modulation format switch described in more detail below. This signal is representing the demodulated signal with high frequencies applied to the demodulator demodulated to logic ones and low frequencies demodulated to logic zeroes. Please note that due to this behaviour a sign inversion of the data occurs in case of high-side injection of the local oscillator at receive frequencies below 840 or 420 MHz , respectively.
The modulation format switch is actually a switchable amplifier with an AC gain of 11 that is controlled by the MSEL pin (Pin 14) as shown in the following table. This gain was chosen to facilitate detection in the subsequent circuits. The DC gain is 1 in order not to saturate the subsequent Data Filter wih the DC offset produced by the demodulator in case of large frequency offsets of the IF signal. The resulting frequency characteristic and details on the principle of operation of the switch are described in Chapter 3.6.

Table 5 MSEL Pin Operating States

| MSEL | Modulation Format |
| :--- | :--- |
| Open | ASK |
| Shorted to ground | FSK |

The demodulator circuit is switched off in case of reception of ASK signals.

### 2.4.7 Data Filter

The data filter comprises an OP-Amp with a bandwidth of 100 kHz used as a voltage follower and two $100 \mathrm{k} \Omega$ onchip resistors. Along with two external capacitors a 2nd order Sallen-Key low pass filter is formed. The selection of the capacitor values is described in Chapter 3.6.

### 2.4.8 Data Slicer

The data slicer is a fast comparator with a bandwidth of 100 kHz . This allows for a maximum receive data rate of up to 100 kBaud . The maximum achievable data rate also depends on the IF Filter bandwidth and the local oscillator tolerance values. Both inputs are accessible. The output delivers a digital data signal (CMOS-like levels) for sbsequent circuits. The self-adjusting threshold on pin 19 its generated by RC-term or peak detector depending on the baseband coding scheme. The data slicer threshold generation alternatives are described in more detail in Chapter 3.5.

### 2.4.9 Peak Detector

The peak detector generates a DC voltage which is proportional to the peak value of the receive data signal. An external RC network is necessary. The input is connected to the output of the RSSI-output of the Limiter, the output is connected to the PDO pin (Pin 26). This output can be used as an indicator for the received signal strength to use in wake-up circuits and as a reference for the data slicer in ASK mode. Note that the RSSI level is also output in case of FSK mode.

### 2.4.10 Bandgap Reference Circuitry

A Bandgap Reference Circuit provides a temperature stable reference voltage for the device. A power down mode is available to switch off all subcircuits which is controlled by the PWDN pin (Pin 27) as shown in the following table. The supply current drawn in this case is typically 50 nA .

Table 6 PDWN Pin Operating States

| PDWN | Operating State |
| :--- | :--- |
| Open or tied to ground | Powerdown Mode |
| Tied to $V_{\mathrm{CC}}$ | Receiver On |

## 3 Applications

### 3.1 Choice of LNA Threshold Voltage and Time Constant

In the following figure the internal circuitry of the LNA automatic gain control is shown.


Figure 5 LNA Automatic Gain Control Circuitry
The LNA automatic gain control circuitry consists of an operational transimpedance amplifier that is used to compare the received signal strength signal (RSSI) generated by the Limiter with an externally provided threshold voltage Uthres. As shown in the following figure the threshold voltage can have any value between approximately 0.8 and 2.8 V to provide a switching point within the receive signal dynamic range.

This voltage Uthres is applied to the THRES pin (Pin 23) The threshold voltage can be generated by attaching a voltage divider between the 3VOUT pin (Pin 24) which provides a temperature stable 3 V output generated from the internal bandgap voltage and the THRES pin. If the RSSI level generated by the Limiter is higher than Uthres, the OTA generates a positive current lload. This yields a voltage rise on the TAGC pin (Pin 2). Otherwise, the OTA generates a negative current. These currents do not have the same values in order to achieve a fast-attack and slow-release action of the AGC and are used to charge an external capacitor which finally generates the LNA gain control voltage.

## Applications



Figure 6 RSSI Level and Permissive AGC Threshold Levels
The switching point should be chosen according to the intended operating scenario. The determination of the optimum point is described in the accompanying Application Note, a threshold voltage level of 1.8 V is apparently a viable choice. It should be noted that the output of the 3VOUT pin is capable of driving up to $50 \mu \mathrm{~A}$, but that the THRES pin input current is only in the region of 40 nA . As the current drawn out of the 3VOUT pin is directly related to the receiver power consumption, the power divider resistors should have high impedance values. The sum of R 1 and R 2 has to be $600 \mathrm{k} \Omega$ in order to yield 3 V at the 3 VOUT pin. R1 can thus be chosen as $240 \mathrm{k} \Omega$, R2 as $360 \mathrm{k} \Omega$ to yield an overall 3 VOUT output current of $5 \mu \mathrm{~A}^{1)}$ and a threshold voltage of 1.8 V .
Note: If the LNA gain shall be kept in either high or low gain mode this has to be accomplished by tying the THRES pin to a fixed voltage. In order to achieve always high gain mode operation, a voltage of at least 2.9 V or higher shall be applied to the THRES pin, such as a short to the 3VOUT pin. In order to achieve low gain mode operation a voltage lower than 0.7 V (depending on the matching and IF-filter) shall be applied to the THRES, such as a short to ground.

As stated above the capacitor connected to the TAGC pin is generating the gain control voltage of the LNA due to the charging and discharging currents of the OTA and thus is also responsible for the AGC time constant. As the charging and discharging currents are not equal two different time constants will result. The time constant corresponding to the charging process of the capacitor shall be chosen according to the data rate. According to measurements performed at Infineon the capacitor value should be higher than 47 nF .

[^0]
### 3.2 Data Filter Design

Utilising the on-board voltage follower and the two $100 \mathrm{k} \Omega$ on-chip resistors a 2nd order Sallen-Key low pass data filter can be constructed by adding 2 external capacitors between pins 18 (SLP) and 22 (FFB) and to pin 20 (OPP) as depicted in the following figure and described in the following formulas ${ }^{11}$.


Figure 7 Data Filter Design
$C 12=\frac{\sqrt{b}}{4 Q R \pi f_{3 d B}}$
$C 14=\frac{2 Q \sqrt{b}}{R 2 \pi f_{3 d B}}$
with
$Q=\frac{\sqrt{b}}{a}$
the quality factor of the poles, where in case of a Bessel filter $a=1.3617, b=0.618$
and thus $Q=0.577$
and in case of a Butterworth filter $a=1.414, b=1$
and thus $Q=0.71$

## Example

Butterworth filter with $\mathrm{f}_{3 \mathrm{~dB}}=5 \mathrm{kHz}$ and $\mathrm{R}=100 \mathrm{k} \Omega$ :
$\mathrm{C} 14=450 \mathrm{pF}, \mathrm{C} 12=225 \mathrm{pF}$

[^1]
### 3.3 Quartz Load Capacitance Calculation

The value of the capacitor necessary to achieve that the quartz oscillator is operating at the intended frequency is determined by the reactive part of the negative resistance of the oscillator circuit as shown in Chapter 4.1.3 and by the quartz specifications given by the quartz manufacturer.


Figure 8 Determination of Series Capacitance Value for the Quartz Oscillator
Crystal specified with load capacitance

$$
\begin{equation*}
C_{S}=\frac{1}{\frac{1}{C_{L}}+2 \pi f X_{L}} \tag{4}
\end{equation*}
$$

with CL the load capacitance (refer to the quartz crystal specification).

## Examples

6.7 MHz: CL $=12 \mathrm{pF}, \mathrm{XL}=695 \Omega, \mathrm{CS}=8.9 \mathrm{pF}$
13.4 MHz: CL $=12 \mathrm{pF}, \mathrm{XL}=1010 \Omega, \mathrm{CS}=5.9 \mathrm{pF}$

These values may be obtained in high accuracy by putting two capacitors in series to the quartz, such as 22 pF and 15 pF in the 6.7 MHz case and 22 pF and 8.2 pF in the 13.4 MHz case.
But please note that the calculated value of CS includes the parasitic capacitors also.

## Applications

### 3.4 Quartz Frequency Calculation

As described in Chapter 2.4.3 the operating range of the on-chip VCO is 820 to 860 MHz with a nominal center frequency of 840 MHz . This signal is divided by 2 before applied to the mixer in case of operation at 434 MHz . This local oscillator signal can be used to downconvert the RF signals both with high- or low-side injection at the mixer. The resulting receive frequency ranges then extend between 810 and 870 MHz or between 400 and 440 MHz . Low-side injection of the local oscillator has to be used for receive frequencies between 840 and 870 MHz as well as high-side injection for receive frequencies below 840 MHz . Corresponding to that in the 400 MHz region lowside injection is applicable for receive frequencies above 420 MHz , high-side injection below this frequency. Therefore for operation both in the 868 and the 434 MHz ISM bands low-side injection of the local oscillator has to be used. Then the local oscillator frequency is calculated by subtracting the IF frequency ( 10.7 MHz ) from the RF frequency ( 434 or 868 MHz ). Please note that for low-side injection no sign-inversion occurs in case of reception and demodulation of FSK-modulated signals.
The overall division ratios in the PLL are 64 or 128 in case of operation at 868 MHz or 32 and 64 in case of operation at 434 MHz , depending on the crystal frequency used as shown below. The quartz frequency in case of low-side injection may be calculated by using the following formula:
$f_{Q U}=\frac{f_{R F} \pm 10.7}{r}$
$f_{\mathrm{RF}} \quad$ Receive frequency
$f_{\text {LO }} \quad$ Local oscillator (PLL) frequency $\left(f_{\mathrm{RF}} \pm 10.7\right)$
$f_{\text {QU }} \quad$ Quartz oscillator frequency
$r \quad$ Ratio of local oscillator (PLL) frequency and quartz, frequency as shown in the subsequent table.

Table 7 Dependence of PLL Overall Division Ratio on FSEL and CSEL

| FSEL | CSEL | Ratio $\mathbf{r}=(\mathrm{fLO} / \mathrm{fQU})$ |
| :--- | :--- | :--- |
| Open | Open | 64 |
| Open | GND | 32 |
| GND | Open | 128 |
| GND | GND | 64 |

Example (low-side injection mode):
$f_{\mathrm{QU}}=(868.4 \mathrm{MHz}-10.7 \mathrm{MHz}) / 64=13.40156 \mathrm{MHz}$
$f_{\mathrm{QU}}=(868.4 \mathrm{MHz}-10.7 \mathrm{MHz}) / 128=6.7008 \mathrm{MHz}$
$f_{\mathrm{QU}}=(434.2 \mathrm{MHz}-10.7 \mathrm{MHz}) / 32=13.23437 \mathrm{MHz}$
$f_{\mathrm{QU}}=(434.2 \mathrm{MHz}-10.7 \mathrm{MHz}) / 64=6.6172 \mathrm{MHz}$

### 3.5 Data Slicer Threshold Generation

The threshold of the data slicer, especially for a coding scheme without DC-content, can be generated using an external R-C integrator as shown in Figure 9. The time constant TA of the R-C integrator has to be significantly larger than the longest period of no signal change TL within the data sequence. For the calculation of the time constant TA please see Application Note „TDA521x_ANV1.1", chapter „4.11 Data Slicer". In order to keep distortion low, the minimum value for $R 1$ is $20 \mathrm{k} \Omega$.


Figure 9 Data Slicer Threshold Generation with External R-C Integrator
In case of ASK operation another possibility for threshold generation is to use the peak detector in connection with two resistors and one capacitor as shown in the following figure. The component values are depending on the coding scheme and the protocol used.


Figure 10 Data Slicer Threshold Generation Utilising the Peak Detector

## Applications

### 3.6 ASK/FSK Switch Functional Description

The TDA7210V is containing an ASK/FSK switch which can be controlled via Pin 14 (MSEL). This switch is actually consisting of 2 operational amplifiers that are having a gain of 1 in case of the ASK amplifier and a gain of 11 in case of the FSK amplifier in order to achieve an appropriate demodulation gain characteristic. In order to compensate for the DC-offset generated especially in case of the FSK PLL demodulator there is a feedback connection between the threshold voltage of the bit slicer comparator (Pin 19) to the negative input of the FSK switch amplifier. This is shown in the following figure.


Figure 11 ASK/FSK Mode Datapath

### 3.6.1 FSK Mode

The FSK datapath has a bandpass characterisitc due to the feedback shown above (highpass) and the data filter (lowpass). The lower cutoff frequency f2 is determined by the external RC-combination. The upper cutoff frequency f 3 is determined by the data filter bandwidth.
The demodulation gain of the FSK PLL demodulator is $200 \mu \mathrm{~V} / \mathrm{kHz}$. This gain is increased by the gain v of the FSK switch, which is 11 . Therefore the resulting dynamic gain of this circuit is $2.2 \mathrm{mV} / \mathrm{kHz}$ within the bandpass. The gain for the DC content of FSK signal remains at $200 \mu \mathrm{~V} / \mathrm{kHz}$. The cutoff frequencies of the bandpass have to be chosen such that the spectrum of the data signal is influenced in an acceptable amount.
In case that the user data is containing long sequences of logical zeroes the effect of the drift-off of the bit slicer threshold voltage can be lowered if the offset voltage inherent at the negative input of the slicer comparator (Pin 19) is used. The comparator has no hysteresis built in.

This offset voltage is generated by the bias current of the negative input of the comparator (i.e. 20 nA ) running over the external resistor R1. This voltage raises the voltage appearing at pin 19 (e.g. 1 mV with R1=100 k $\Omega$ ). In order to obtain benefit of this asymmetrical offset for the demodulation of long zeros the lower of the two FSK frequencies should be chosen in the transmitter as the zero-symbol frequency.

In the following figure the shape of the above mentioned bandpass is shown.


Figure 12 Frequency Characterstic in Case of FSK Mode
The cutoff frequencies are calculated with the following formulas:
$f_{1}=\frac{1}{2 \pi \frac{R 1 \cdot 330 k \Omega}{R 1+330 k \Omega} \cdot C 13}$
$f_{2}=v \cdot f_{1}=11 \cdot f_{1}$
$f_{3}=f_{3 d B}$
f 3 is the 3 dB cutoff frequency of the data filter - see Section 3.2.

Example:
$\mathrm{R} 1=100 \mathrm{k} \Omega, \mathrm{C} 13=47 \mathrm{nF}$
This leads to $\mathrm{f} 1=44 \mathrm{~Hz}$ and $\mathfrak{f} 2=485 \mathrm{~Hz}$

### 3.6.2 ASK Mode

In case the receiver is operated in ASK mode the datapath frequency charactersitic is dominated by the data filter alone, thus it is lowpass shaped. The cutoff frequency is determined by the external capacitors C12 and C14 and the internal 100k resistors as described in Chapter 3.2.


Figure 13 Frequency Charcteristic in Case of ASK Mode

### 3.7 Principle of the Precharge Circuit

In case the data slicer threshold shall be generated with an external RC network as described in Chapter 3.5 it is necessary to use large values for the capacitor C13 attached to the SLN pin (pin 19) in order to achieve long time constants. This results also from the fact that the choice of the value for R1 connected between the SLP and SLN pins (pins 18 and 19) is limited by the $330 \mathrm{k} \Omega$ resistor appearing in parallel to R 1 as can be seen in Figure 11. Apart from this a resistor value of $100 \mathrm{k} \Omega$ leads to a voltage offset of 1 mV at the comparator input as described in Chapter 3.6.1. The resulting startup time constant t 1 can be calculated with:
$\tau_{1}=(R 1 \| 330 k \Omega) \times C 13$
In case R1 is chosen to be $100 \mathrm{k} \Omega$ and C 13 is chosen as 47 nF this leads to
$\tau_{1}=(100 k \Omega \| 330 k \Omega) \times 47 n F=77 k \Omega \times 47 n F=3.6 \mathrm{~ms}$

When the device is turned on this time constant dominates the time necessary for the device to be able to demodulate data properly. In the powerdown mode the capacitor is only discharged by leakage currents.
In order to reduce the turn-on time in the presence of large values of C13 a precharge circuit was included in the TDA7210V as shown in the following figure.


Figure 14 Principle of the Precharge Circuit
This circuit charges the capacitor C 13 with an inrush current lload of typically $220 \mu \mathrm{~A}$ for a duration of T2 until the voltage Uc appearing on the capacitor is equal to the voltage Us at the input of the data filter. This voltage is limited to 2.5 V . As soon as these voltages are equal or the duration T 2 is exceeded the precharge circuit is disabled.
t2 is the time constant of the charging process of C18 which can be calculated as:
$\tau_{2}=20 \mathrm{k} \Omega \times C 18$
As the sum of R4 and R5 is sufficiently large and thus can be neglected. T2 can then be calculated according to the following formula:
$T_{l}=\tau_{2} \ln \left(\frac{1}{1-\frac{2.4 V}{3 V}}\right) \approx \tau_{2} \times 1.6$
The voltage transient during the charging of C 18 is shown in the following figure:


Figure 15 Voltage Appearing on C18 During Precharging Process
The voltage appearing on the capacitor C 13 connected to pin 20 is shown in the following figure. It can be seen that due to the fact that it is charged by a constant current source it exhibits is a linear increase in voltage which is limited to USmax $=2.5 \mathrm{~V}$ which is also the approximate operating point of the data filter input. The time constant appearing in this case can be denoted as T3, which can be calculated with
$\mathrm{T} 3=\frac{\mathrm{U}_{\mathrm{Smax}} \cdot \mathrm{C} 13}{220 \mu \mathrm{~A}}=\frac{2,5 \mathrm{~V}}{220 \mu \mathrm{~A}} \cdot \mathrm{C} 13$


Figure 16 Voltage Transient on Capacitor C13 Attached to Pin 19

## Applications

As an example the choice of $\mathrm{C} 18=22 \mathrm{nF}$ and $\mathrm{C} 13=47 \mathrm{nF}$ yields
$\mathrm{t} 2=0.44 \mathrm{~ms}$
$\mathrm{T} 2=0.71 \mathrm{~ms}$
$\mathrm{T} 3=0.53 \mathrm{~ms}$
This means that in this case the inrush current could flow for a duration of 0.64 ms but stops already after 0.49 ms when the USmax limit has been reached. T3 should always be chosen to be shorter than T2.
It has to be noted finally that during the turn-on duration T2 the overall device power consumption is increased by the $220 \mu \mathrm{~A}$ needed to charge C 13 .
The precharge circuit may be disabled if C18 is not equipped. This yields a T2 close to zero. Note that the sum of R 4 and R 5 has to be $600 \mathrm{k} \Omega$ in order to produce 3 V at the THRES pin as this voltage is internally used also as the reference for the FSK demodulator.

## 4 Electrical Characteristics

### 4.1 Electrical Data

### 4.1.1 Absolute Maximum Ratings

Attention: TDA7210V is intended for use in general electronic equipment (AV equipment, telecommunication equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment) under a normal operation and use condition.

Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.

Table 8 Absolute Maximum Ratings, Ambient temperature $\mathrm{T}_{\text {AMB }}=-40^{\circ} \mathrm{C} \ldots+85^{\circ} \mathrm{C}$

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test | Number |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |  |  |
| Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ | -0.3 | - | 5.5 | V |  | 1.1 |  |
| Junction Temperature | $\mathrm{T}_{\mathrm{j}}$ | -40 | - | +125 | ${ }^{\circ} \mathrm{C}$ |  | 1.2 |  |
| Storage Temperature | $\mathrm{T}_{\mathrm{S}}$ | -40 | - | +125 | ${ }^{\circ} \mathrm{C}$ |  | 1.3 |  |
| Thermal Resistance | $\mathrm{R}_{\mathrm{th}} \mathrm{JA}$ | - | - | tbd. | $\mathrm{K} / \mathrm{W}$ |  | 1.4 |  |
| ESD HBM integrity <br> (all pins) | $\mathrm{V}_{\mathrm{ESD}}$ | - | - | $\pm 2$ | kV | AEC Q100-002 |  |  |
| ESD SDM integrity <br> (all pins) | $\mathrm{V}_{\mathrm{ESD}}$ | - | - | $\pm 500$ | V | AINSI/ESD5.3.2-2008 |  | 1.6 |
| ESD SDM integrity <br> (corner pins) | $\mathrm{V}_{\mathrm{ESD}}$ | - | - | $\pm 750$ | V |  |  | 1.5 |

### 4.1.2 Operating Range

Within the operational range the IC operates as explained in the circuit description. The AC/DC characteristic limits are not guaranteed. Currents flowing into the device are denoted as positive currents and v.v.
Supply voltage: $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} . .5 .5 \mathrm{~V}$

Table 9 Operating Range, Ambient temperature $\mathrm{T}_{\mathrm{AMB}}=-40^{\circ} \mathrm{C} \ldots+85^{\circ} \mathrm{C}$

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test | Num ber |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |  |  |
| Supply Current | $\mathrm{I}_{\text {SF } 868}$ | 4.1 | - | 7.7 | mA | $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$, FSK Mode |  | 2.1 |
|  | $\mathrm{I}_{\text {SF } 434}$ | 3.9 | - | 7.5 | mA | $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$, FSK Mode |  | 2.2 |
|  | $\mathrm{I}_{\text {SA } 868}$ | 3.4 | - | 7 | mA | $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$, ASK Mode |  | 2.3 |
|  | $\mathrm{I}_{\text {SA } 434}$ | 3.2 | - | 6.8 | mA | $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$, ASK Mode |  | 2.4 |

## Electrical Characteristics

Table 9 Operating Range, Ambient temperature $\mathrm{T}_{\text {AMB }}=-40^{\circ} \mathrm{C} \ldots+85^{\circ} \mathrm{C}$ (cont'd)

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test | Num ber |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |  |  |
| Receiver Input Level ASK, $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $R F_{\text {in }}$ | -116 | - | -13 | dBm | @ source imp. $50 \Omega$, BER 2E-3, average power level, Manchester enc. datarate 1 kBit, 280 kHz IF Bandwidth |  | 2.5 |
| Receiver Input Level FSK, frequ. dev. $\pm 50 \mathrm{kHz}$ $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $R F_{\text {in }}$ | -113 | - | -13 | dBm |  | $\square$ | 2.6 |
| Receiver Input Level ASK, $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $R F_{\text {in }}$ | -112 |  | -13 |  | @ source impedance $50 \Omega$, BER 2E-3, average power level, Manchester encoded datarate 1 kBit, 280 kHz IF Bandwidth | $\square$ | 2.7 |
| Receiver Input Level FSK, frequ. dev. $\pm 50 \mathrm{kHz}$ $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $R F_{\text {in }}$ | -112 |  | -13 |  |  | $\square$ | 2.8 |
| LNI Input Frequency | $\mathrm{f}_{\mathrm{RF}}$ | $\begin{aligned} & 400 / \\ & 810 \end{aligned}$ | - | $\begin{aligned} & 440 / \\ & 870 \end{aligned}$ | MHz |  |  | 2.9 |
| M/X Input Frequency | $\mathrm{f}_{\mathrm{MI}}$ | $\begin{aligned} & 400 / \\ & 810 \end{aligned}$ | - | $\begin{aligned} & 440 / \\ & 870 \end{aligned}$ | MHz |  |  | 2.10 |
| 3 dB IF Frequency Range ASK | $\mathrm{f}_{\text {IF }-3 \mathrm{~dB}}$ | 5 | - | 23 | MHz |  | - | 2.11 |
| 3 dB IF Frequency Range FSK | $\mathrm{f}_{\mathrm{IF}-3 \mathrm{~dB}}$ | 10.4 | - | 11 | MHz |  | $\square$ | 2.12 |
| Power Mode Standby | Standby | 0 | - | 0.8 | V |  |  | 2.13 |
| Power Mode On | ON | 2.8 | - | $\mathrm{V}_{\mathrm{CC}}$ | V |  |  | 2.14 |
| Gain Control Voltage, LNA high gain state | $\mathrm{V}_{\text {THRES }}$ | 2.8 | - | $\mathrm{V}_{\mathrm{cc}}{ }^{-1}$ | V |  |  | 2.15 |
| Gain Control Voltage, LNA low gain state | $\mathrm{V}_{\text {THRES }}$ | 0 | - | 0.7 | V |  |  | 2.16 |

Attention: Test $\square$ means that the parameter is not subject to production test. It was verified by design/characterization.

### 4.1.3 $\quad \mathrm{AC} / \mathrm{DC}$ Characteristics at $\mathrm{T}_{\mathrm{AMB}}=25^{\circ} \mathrm{C}$

AC/DC characteristics involve the spread of values guaranteed within the specified voltage and ambient temperature range. Typical characteristics are the median of the production. Currents flowing into the device are denoted as positive currents and vice versa. The device performance parameters marked with $\square$ are not subject to production test. They were verified by design/characterization.

Table 10 AC/DC Characteristics with $\mathrm{T}_{\mathrm{AMB}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=4.5 \ldots 5.5 \mathrm{~V}$

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test | Num <br> ber |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |  |  |

LNA - Signal Input LNI (PIN 1), $\mathrm{V}_{\text {THRES }}>\mathbf{2 . 8} \mathrm{V}$, high gain mode

| Average Power Level at $B E R=2 E-3$ (Sensitivity) ASK $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $R F_{\text {in }}$ | - | -112 | - | dBm | Manchester encoded datarate 4 kBit, 280 kHz IF Bandwidth | ■ | 3.6 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Average Power Level at $B E R=2 E-3$ (Sensitivity) FSK $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $R F_{\text {in }}$ | - | -108 | - | dBm | Manchester enc. datarate 4 kBit, 280 kHz IF Bandw., $\pm 50 \mathrm{kHz}$ pk. dev. | - | 3.7 |
| Average Power Level at $B E R=2 E-3$ (Sensitivity) ASK $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $R F_{\text {in }}$ | - | -108 | - | dBm | Manchester encoded datarate $4 \mathrm{kBit}, 280 \mathrm{kHz}$ IF Bandwidth | - | 3.8 |
| Average Power Level at $B E R=2 E-3$ (Sensitivity) FSK $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $R F_{\text {in }}$ | - | -107 | - | dBm | Manchester enc. datarate 4 kBit, 280 kHz IF Bandw., $\pm 50 \mathrm{kHz}$ pk. dev | $\square$ | 3.9 |
| Average Power Level at $B E R=2 E-3$ (Sensitivity) ASK $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $R F_{\text {in }}$ | - | -115 | - | dBm | Manchester encoded datarate $1 \mathrm{kBit}, 280 \mathrm{kHz}$ IF Bandwidth | $\square$ | 3.10 |
| Average Power Level at $B E R=2 E-3$ (Sensitivity) FSK $f_{R F}=434 \mathrm{MHz}$ | $R F_{\text {in }}$ | - | -112 | - | dBm | Manchester enc. datarate 1 kBit, 280 kHz IF Bandw., $\pm 50 \mathrm{kHz}$ pk. dev. | $\square$ | 3.11 |
| Average Power Level at $B E R=2 E-3$ (Sensitivity) ASK $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $R F_{\text {in }}$ | - | -111 | - | dBm | Manchester encoded datarate $1 \mathrm{kBit}, 280 \mathrm{kHz}$ IF Bandwidth | $\square$ | 3.12 |

TDA7210V

Electrical Characteristics

Table 10 AC/DC Characteristics with $\mathrm{T}_{\text {AMB }}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=4.5 \ldots 5.5 \mathrm{~V}$ (cont'd)

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test | Num ber |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |  |  |
| $\begin{aligned} & \text { Average Power Level } \\ & \text { at } B E R=2 E-3 \text { (Sensitivity) } \\ & F S K f_{R F}=868 \mathrm{MHz} \end{aligned}$ | $R F_{\text {in }}$ | - | -111 | - | dBm | Manchester enc. datarate $1 \mathrm{kBit}, 280 \mathrm{kHz}$ IF Bandw., $\pm 50 \mathrm{kHz}$ pk. dev. | $\square$ | 3.13 |
| Input impedance, $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $\mathrm{S}_{11 \text { LNA }}$ |  | $\begin{aligned} & 0.890 / \\ & -36.3 \\ & \text { deg } \end{aligned}$ |  |  |  | $\square$ | 3.14 |
| Input impedance, $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{S}_{11 \text { LNA }}$ |  | $\begin{aligned} & 0.784 \text { / } \\ & -66.2 \\ & \text { deg } \end{aligned}$ |  |  |  | $\square$ | 3.15 |
| $\begin{aligned} & \text { Input level @ } 1 \text { dB C.P. } \mathrm{f}_{\mathrm{RF}}= \\ & 434 \mathrm{MHz} \end{aligned}$ | P1dB ${ }_{\text {LNA }}$ | - | -16 | - | dBm | Matched input | - | 3.16 |
| Input level @ 1 dB C.P. $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | P1dB ${ }_{\text {LNA }}$ | - | -7 | - | dBm | Matched input | - | 3.17 |
| Input 3rd order intercept point $f_{R F}=434 \mathrm{MHz}$ | IIP3 ${ }_{\text {LNA }}$ | - | -21 | - | dBm | Matched input | $\square$ | 3.18 |
| Input 3rd order intercept point $f_{R F}=868 \mathrm{MHz}$ | IIP3 ${ }_{\text {LNA }}$ | - | -14 | - | dBm | Matched input | $\square$ | 3.19 |
| LO signal feedthrough at antenna port | $\mathrm{LO}_{\mathrm{LN} \text { I }}$ | - | -83 | -73 | dBm |  | $\square$ | 3.20 |

LNA - Signal Output LNO (PIN 4), $\mathrm{V}_{\text {THRES }}>2.8 \mathrm{~V}$, high gain mode

| Gain $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $\mathrm{S}_{21 \text { LNA }}$ |  | $1.497 /$ <br> 137.0 <br> deg |  |  |  | ■ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Gain $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{S}_{21 \text { LNA }}$ |  | $1.298 /$ <br> 103.7 <br> deg |  |  |  | ■ |
| Output impedance, <br> $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $\mathrm{S}_{22 \text { LNA }}$ |  | $0.899 /$ <br> -16.4 <br> deg |  |  |  | 3.22 |
| Output impedance, <br> $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{S}_{22 \text { LNA }}$ |  | $0.885 /$ <br> -25.7 <br> deg |  |  |  | ■ |

LNA- Signal Input LNI, $\mathrm{V}_{\text {THRES }}=$ GND, low gain mode

| Input impedance, <br> $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $\mathrm{S}_{11 \mathrm{LNA}}$ |  | $0.896 /$ <br> -37.1 <br> deg |  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Input impedance, <br> $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{S}_{11 \mathrm{LNA}}$ |  | $0.794 /$ <br> -69.1 <br> deg |  |  |  |  |  |
| Input level @ 1 dB C. P. <br> $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $\mathrm{P} 1 \mathrm{~dB}_{\mathrm{LNA}}$ | - | -7 | - | dBm | Matched input |  |  |
| Input level @ 1 dB C. P. <br> $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{P} 1 \mathrm{~dB}_{\mathrm{LNA}}$ | - | -3 | - | dBm | Matched input | ■ | 3.27 |

Table $10 \mathrm{AC} / \mathrm{DC}$ Characteristics with $\mathrm{T}_{\mathrm{AMB}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=4.5 \ldots 5.5 \mathrm{~V}$ (cont'd)

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test | Num ber |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |  |  |
| Input 3rd order intercept point $f_{R F}=434 \mathrm{MHz}$ | IIP3 ${ }_{\text {LNA }}$ | - | -19 | - | dBm | Matched input | - | 3.29 |
| Input 3rd order intercept point $f_{R F}=868 \mathrm{MHz}$ | IIP3 ${ }_{\text {LNA }}$ | - | -13 | - | dBm | Matched input | - | 3.30 |
| LNA - Signal Output LNO, $\mathrm{V}_{\text {THRES }}=\mathrm{GND}$, low gain mode |  |  |  |  |  |  |  |  |
| Gain $\mathrm{f}_{\text {RF }}=434 \mathrm{MHz}$ | $\mathrm{S}_{21 \text { LNA }}$ |  | $\begin{aligned} & \hline 0.180 / \\ & 138.1 \\ & \text { deg } \end{aligned}$ |  |  |  | ■ | 3.31 |
| Gain $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{S}_{21 \text { LNA }}$ |  | $\begin{aligned} & 0.162 \text { / } \\ & 109.6 \\ & \text { deg } \\ & \hline \end{aligned}$ |  |  |  | $\square$ | 3.32 |
| Output impedance, $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $\mathrm{S}_{22 \mathrm{LNA}}$ |  | $\begin{aligned} & 0.904 / \\ & -16.0 \\ & \text { deg } \end{aligned}$ |  |  |  | - | 3.33 |
| Output impedance, $f R F=868 \mathrm{MHz}$ | $\mathrm{S}_{22 \mathrm{LNA}}$ |  | $\begin{aligned} & 0.888 / \\ & -26.4 \\ & \operatorname{deg} \end{aligned}$ |  |  |  | $\square$ | 3.34 |

LNA - Antenna to IFO, $\mathrm{V}_{\text {THRES }} \mathbf{> 2 . 8} \mathrm{V}$, high gain mode

| Voltage Gain Antenna to <br> IFO $f_{R F}=434 ~ M H z$ | $\mathrm{G}_{\text {Ant-IFO }}$ | - | 51 | - | dB |  |  | 3.35 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Voltage Gain Antenna to <br> IFO $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{G}_{\text {Ant-IFO }}$ | - | 47 | - | dB |  | 3.36 |  |

LNA - Antenna to IFO, V $_{\text {THRES }}=$ GND, low gain mode

| Voltage Gain Antenna to <br> IFO $f_{R F}=434 ~ M H z ~$ | $\mathrm{G}_{\text {Ant-IFO }}$ | - | 36 | - | dB |  |  | 3.37 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Voltage Gain Antenna to <br> IFO $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{G}_{\text {Ant-IFO }}$ | - | 28 | - | dB |  | 3.38 |  |

3VOUT - Signal 3VOUT (PIN 24)

| Output voltage | $\mathrm{V}_{\text {3VOUT }}$ | 2.9 | 3.1 | 3.3 | V | 3VOUT Pin open |  | 3.39 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Current out | $\mathrm{I}_{\text {3VOUT }}$ | -3 | -5 | -10 | $\mu \mathrm{~A}$ | See Chapter 3. | 3.40 |  |

AGC - Signal THRES (PIN 23)

| Input Voltage range | $\mathrm{V}_{\text {THRES }}$ | 0 | - | $\mathrm{V}_{\mathrm{CC}}-1$ | V | See Chapter 3. |  | 3.41 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| LNA low gain mode | $\mathrm{V}_{\text {THRES }}$ | 0 | - | - | V |  | 3.42 |  |
| LNA high gain mode | $\mathrm{V}_{\text {THRES }}$ | 2.9 | 3.0 | $\mathrm{~V}_{\mathrm{CC}}-1$ | V | Voltage must not be <br> higher than $\mathrm{V}_{\mathrm{CC}}-1 \mathrm{~V}$ |  | 3.43 |
| Current in | $\mathrm{I}_{\text {THRES_in }}$ | - | 5 | - | nA | $\mu \mathrm{A}$ | $\square$ | 3.44 |

AGC - Signal TAGC (PIN 2)

| Current out <br> LNA low gain state | $\mathrm{I}_{\text {TAGC_out }}$ | -3.6 | -4.2 | -5 | $\mu \mathrm{~A}$ | $\mathrm{RSSI}>\mathrm{V}_{\text {THRES }}$ |  | 3.45 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Current in <br> LNA high gain state | $\mathrm{I}_{\text {TAGC_in }}$ | 1 | 1.5 | 2.2 | $\mu \mathrm{~A}$ | $R S S I<\mathrm{V}_{\text {THRES }}$ | 3.46 |  |

Table 10 AC/DC Characteristics with $\mathrm{T}_{\text {AMB }}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=4.5 \ldots 5.5 \mathrm{~V}$ (cont'd)

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test | Num ber |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |  |  |
| MIXER - Signal Input MI/MIX (PINS 6/7) |  |  |  |  |  |  |  |  |
| Input impedance, $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $\mathrm{S}_{11 \text { MIX }}$ |  | $\begin{aligned} & \hline 0.936 / \\ & -15.2 \\ & \text { deg } \end{aligned}$ |  |  |  | - | 3.47 |
| Input impedance, $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{S}_{11 \text { MIX }}$ |  | $\begin{aligned} & 0.917 / \\ & -27.6 \\ & \text { deg } \end{aligned}$ |  |  |  | - | 3.48 |
| Input 3rd order intercept point $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $\mathrm{IIP}_{3} \mathrm{MIX}$ | - | -42 | - | dBm |  | - | 3.49 |
| Input 3rd order intercept point $f_{R F}=868 \mathrm{MHz}$ | $\mathrm{IIP}_{3 \mathrm{MIX}}$ | - | -42 | - | dBm |  | - | 3.50 |

MIXER - Signal Output IFO (PIN 10)

| Output impedance | $\mathrm{Z}_{\text {IFO }}$ | - | 330 | - | $\Omega$ | $\square$ | 3.51 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Conversion Voltage Gain $\mathrm{f}_{\mathrm{RF}}=434 \mathrm{MHz}$ | $\mathrm{G}_{\text {MIX }}$ | - | 24 | - | dB |  | 3.52 |
| Conversion Voltage Gain $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{G}_{\text {MIX }}$ | - | 31 | - | dB |  | 3.53 |
| LIMITER - Signal Input LIM/X (PINS 16/17) |  |  |  |  |  |  |  |
| Input Impedance | $\mathrm{Z}_{\text {LIM }}$ | 264 | 330 | 396 | $\Omega$ | - | 3.54 |
| RSSI dynamic range | $\mathrm{DR}_{\text {RSSI }}$ | 60 | - | 80 | dB | - | 3.55 |
| RSSI linearity | $\mathrm{LIN}_{\text {RSS }} \mathrm{l}$ | - | $\pm 1$ | - | dB | $\square$ | 3.56 |
| Operating frequency <br> (3 dB points) | $\mathrm{f}_{\text {LIM }}$ | 5 | 10.7 | 23 | MHz | - | 3.57 |

LIMITER - DATA FILTER

| Useable bandwidth | BW <br> BB <br> FILT | - | - | 100 | kHz |  | ■ | 3.58 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| RSSI Level at Data Filter <br> Output SLP, <br> RFIN=-103 dBm <br> RSSI $_{\text {low }}$ | - | 1.39 | - | V | LNA in high gain mode <br> $R F=434 \mathrm{MHz}$ |  | 3.59 |  |
| RSSI Level at Data Filter <br> Output SLP, RFIN=-30 dBm | RSSI $_{\text {high }}$ | - | 2.79 | - | V | LNA in high gain mode <br> $R F=434 \mathrm{MHz}$ | 3.60 |  |

## SLICER - Signal Output DATA (PIN 25)

| Maximum Datarate | $\mathrm{DR}_{\max }$ | - | - | 100 | $\mathrm{kB} / \mathrm{s}$ | NRZ, 20 pF capacitive <br> loading | $\boxed{3.61}$ |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| LOW output voltage | $\mathrm{V}_{\text {SLIC_L }}$ | 0 | - | 0.1 | V |  |  |  |
| HIGH output voltage | $\mathrm{V}_{\text {SLIC_H }}$ | $\mathrm{V}_{\mathrm{CC}}-1.3$ | $\mathrm{~V}_{\mathrm{CC}}-1$ | $\mathrm{~V}_{\mathrm{CC}}-0.7$ | V | Output current $=200 \mu \mathrm{~A}$ |  | 3.63 |

## SLICER - Signal SLN (PIN 19)

| Precharge Current Out | $\mathrm{I}_{\text {PCH_SLN }}$ | -100 | -220 | -300 | $\mu \mathrm{~A}$ | See Chapter 3. |  | 3.64 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

PEAK DETECTOR - Signal Output PDO (PIN 26)

Table 10 AC/DC Characteristics with $\mathrm{T}_{\mathrm{AMB}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=4.5 \ldots 5.5 \mathrm{~V}$ (cont'd)

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test | Num ber |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |  |  |
| Load current | $\mathrm{I}_{\text {load }}$ | -500 | - | - | $\mu \mathrm{A}$ | Static load current must not exceed $-500 \mu \mathrm{~A}$ |  | 3.65 |
| Leakage current | $I_{\text {leakage }}$ | 0 | 200 | 1000 | nA |  |  | 3.66 |

CRYSTAL OSCILLATOR - Signals CRST1, CRST2, (PINS 30/28)

| Operating frequency | $\mathrm{f}_{\mathrm{CRSTL}}$ | 6 | - | 14 | MHz | Fundamental mode, <br> series resonance |  | 3.67 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Input Impedance @ $\sim 6 \mathrm{MHz}$ | $\mathrm{Z}_{1-28}$ | - | -825 <br> +j 695 | - | $\Omega$ |  | $\boxed{ }$ | 3.68 |
| Input Impedance @ <br> $\sim 13 \mathrm{MHz}$ | $\mathrm{Z}_{1-28}$ | - | -600 <br> +j 1010 | - | $\Omega$ |  | $\boxed{ }$ | 3.69 |
| Serial Capacity @ $\sim 6 \mathrm{MHz}$ | $\mathrm{C}_{\mathrm{S} 6}=\mathrm{C} 1$ | - | 8.9 | - | pF |  | 3.70 |  |
| Serial Capacity @ $\sim 13 \mathrm{MHz}$ | $\mathrm{C}_{\mathrm{S} 13}=\mathrm{C} 1$ | - | 5.9 | - | pF |  | 3.71 |  |

ASK/FSK SIGNAL SWITCH - Signal MSEL (PIN 14)

| ASK Mode | $\mathrm{V}_{\text {MSEL }}$ | 1.4 | - | $4^{1)}$ | V | Or open |  | 3.72 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| FSK Mode | $\mathrm{V}_{\text {MSEL }}$ | 0 | - | 0.2 | V |  | 3.73 |  |

FSK DEMODULATOR

| Demodulation Gain | $G_{\text {FMDEM }}$ | - | 200 | - | $\mu \mathrm{V} /$ <br> kHz |  |  | 3.74 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Useable IF Bandwidth | $\mathrm{BW}_{\text {IFPLL }}$ | 10.2 | 10.7 | 11.2 | MHz |  | 3.75 |  |

POWER DOWN MODE - Signal PDWN (PIN 27)

| Power Mode On | ON | 2.8 | - | $\mathrm{V}_{\mathrm{CC}}$ | V |  |  | 3.76 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Power Mode Standby | Standby | 0 | - | 0.8 | V |  | 3.77 |  |
| Input bias current PDWN | $\mathrm{I}_{\text {PDWN }}$ | - | 19 | - | $\mu \mathrm{A}$ | Power On Mode |  | 3.78 |
| Start-up Time until valid <br> signal is detected at IF | $\mathrm{T}_{\text {SU }}$ | - | $<1$ | - | ms | Depends on the used <br> crystal | 3.79 |  |

## VCO MULTIPLEXER - Signal FSEL (PIN 9)

| $\mathrm{f}_{\mathrm{RF}}$ range 434 MHz | $\mathrm{V}_{\text {FSEL }}$ | 1.4 | - | $4^{1)}$ | V | Or open |  | 3.80 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{f}_{\text {RF }}$ range 868 MHz | $\mathrm{V}_{\text {FSEL }}$ | 0 | - | 0.2 | V |  | 3.81 |  |
| Output bias current FSEL | $\mathrm{I}_{\text {FSEL }}$ | -160 | -200 | -240 | $\mu \mathrm{~A}$ | FSEL tied to GND |  | 3.82 |

## PLL DIVIDER - Signal CSEL (PIN 15)

| $\mathrm{f}_{\mathrm{CRSTL}}$ range 6.xxMHz | $\mathrm{V}_{\text {CSEL }}$ | 1.4 | - | $4^{1)}$ | V | or open |  | 3.83 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{f}_{\mathrm{CRSTL}}$ range 13.xxMHz | $\mathrm{V}_{\text {CSEL }}$ | 0 | - | 0.2 | V |  | 3.84 |  |
| Input bias current CSEL | $\mathrm{I}_{\text {CSEL }}$ | -3 | -5 | -7 | $\mu \mathrm{~A}$ | CSEL tied to GND |  | 3.85 |

1) Maximum voltage in Power-On state is 4 V , but in PDWN-state the maximum voltage is 2.8 V .

## Attention: Test means that the parameter is not subject to production test. It was verified by design/characterization.

TDA7210V

Electrical Characteristics

### 4.1.4 $\quad \mathrm{AC} / \mathrm{DC}$ Characteristics at $\mathrm{T}_{\mathrm{AMB}}=-\mathbf{4 0}$ to $85^{\circ} \mathrm{C}$

Currents flowing into the device are denoted as positive currents and vice versa.

Table 11 AC/DC Characteristics with $T_{A M B}=-40^{\circ} \mathrm{C} \ldots+85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=4.5 \ldots 5.5 \mathrm{~V}$

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Number |  |  |  |  |  |
|  |  | Min. | Max. |  |  |  |  |

Supply - Supply Current

| Supply Current Standby Mode | $\mathrm{I}_{\text {SPDWN }}$ | - | 50 | 400 | nA | Pin 27 (PDWN) open or tied to 0 V | 4.1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Current Device operating in 868 MHz range, FSK mode | $\mathrm{I}_{\text {SF } 868}$ | 4.1 | 5.9 | 7.7 | mA | Pin 9 (FSEL) tied to GND, Pin 14 (MSEL) tied to GND | 4.2 |
| Supply Current <br> Device operating in 434 MHz range, FSK mode | $\mathrm{I}_{\text {SF } 434}$ | 3.9 | 5.7 | 7.5 | mA | Pin 9 (FSEL) open, Pin 14 (MSEL) tied to GND | 4.3 |
| Supply Current Device operating in 868 MHz range, ASK mode | $\mathrm{I}_{\text {SA } 868}$ | 3.4 | 5.2 | 7 | mA | Pin 9 (FSEL) tied to GND, Pin 14 (MSEL) open | 4.4 |
| Supply Current Device operating in 434 MHz range, ASK mode | $\mathrm{I}_{\text {SA } 434}$ | 3.2 | 5 | 6.8 | mA | Pin 9 (FSEL) open, Pin 14 (MSEL) open | 4.5 |

3VOUT - Signal 3VOUT (PIN 24)

| Output voltage | $\mathrm{V}_{\text {3VOUT }}$ | 2.9 | 3.1 | 3.3 | V | 3VOUT Pin open |  | 4.6 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Current out | $\mathrm{I}_{\text {3VOUT }}$ | -3 | -5 | -10 | $\mu \mathrm{~A}$ | See Chapter 3. | 4.7 |  |

AGC - Signal THRES (PIN 23)

| Input Voltage range | $\mathrm{V}_{\text {THRES }}$ | 0 | - | $\mathrm{V}_{\mathrm{CC}}-1$ | V | See Chapter 3. |  | 4.8 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| LNA low gain mode | $\mathrm{V}_{\text {THRES }}$ | 0 | - | 0.3 | V |  | 4.9 |  |
| LNA high gain mode | $\mathrm{V}_{\text {THRES }}$ | 2.9 | 3 | 3.3 | V | Voltage must not be higher <br> than VCC-1V | 4.10 |  |
| Current in | $\mathrm{I}_{\text {THRES_in }}$ | - | 5 | - | nA |  | $\boxed{ }$ | 4.11 |

AGC - Signal TAGC (PIN 2)

| Current out <br> LNA low gain state | $\mathrm{I}_{\text {TAGC_out }}$ | -1 | -4.2 | -8 | $\mu \mathrm{~A}$ | $\mathrm{RSSI}>\mathrm{V}_{\text {THRES }}$ | 4.12 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Current in <br> LNA high gain state | $\mathrm{I}_{\text {TAGC_in }}$ | 0.5 | 1.5 | 5 | $\mu \mathrm{~A}$ | $\mathrm{RSSI}<\mathrm{V}_{\text {THRES }}$ | 4.13 |

MIXER

| Conversion Voltage <br> Gain $f_{R F}=434 \mathrm{MHz}$ | $\mathrm{G}_{\mathrm{MIX}}$ | - | 24 | - | dB |  |  | 4.14 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Conversion Voltage <br> Gain $\mathrm{f}_{\mathrm{RF}}=868 \mathrm{MHz}$ | $\mathrm{G}_{\mathrm{MIX}}$ | - | 32 | - | dB |  | 4.15 |  |

Table 11 AC/DC Characteristics with $\mathrm{T}_{\mathrm{AMB}}=-40^{\circ} \mathrm{C} \ldots+85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=4.5 \ldots 5.5 \mathrm{~V}$ (cont'd)

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test | Number |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |  |  |

## LIMITER - Signal Input LIM/X (PINS 16/17)

| RSSI dynamic range | DR RSSI | 60 | - | 80 | dB |  | 4.16 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LIMITER - DATA FILTER |  |  |  |  |  |  |  |
| RSSI Level at Data Filter Output SLP, RFIN $=-103 \mathrm{dBm}$ | RSSI ${ }_{\text {low }}$ | - | 1.39 | - | dB | LNA in high gain mode RF $=434 \mathrm{MHz}$ | 4.17 |
| RSSI Level at Data <br> Filter Output SLP, <br> RFIN=-30 dBm | $\mathrm{RSSI}_{\text {high }}$ | - | 2.79 | - | dB | LNA in high gain mode RF=434 MHz | 4.18 |

## SLICER - Signal Output DATA (PIN 25)

| Maximum Datarate | DR $_{\max }$ | - | - | 100 | $\mathrm{kB} / \mathrm{s}$ | NRZ, 20 pF capacitive <br> loading | ■ | 4.19 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| LOW output voltage | $\mathrm{V}_{\text {SLIC_L }}$ | 0 | - | 0.1 | V |  | 4.20 |  |
| HIGH output voltage | $\mathrm{V}_{\text {SLIC_H }}$ | $\mathrm{V}_{\mathrm{CC}}-1.5$ | $\mathrm{~V}_{\mathrm{CC}}-1$ | $\mathrm{~V}_{\mathrm{CC}}-0.5$ | V | Output current $=200 \mu \mathrm{~A}$ | 4.21 |  |

SLICER - Signal SLN (PIN 19)

| Precharge Current <br> Out | $\mathrm{I}_{\text {PCH_SLN }}$ | -100 | -220 | -300 | $\mu \mathrm{~A}$ | See Chapter 3. | 4.22 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

PEAK DETECTOR - Signal Output PDO (PIN 26)

| Load current | $\mathrm{I}_{\text {load }}$ | -400 | - | - | $\mu \mathrm{A}$ | Static load current must not <br> exceed $-500 \mu \mathrm{~A}$ | 4.23 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Leakage current | $\mathrm{I}_{\text {leakage }}$ | 0 | 700 | 2000 | nA |  | 4.24 |

CRYSTAL OSCILLATOR - Signals CRST1, CRST2, (PINS 30/28)

| Operating frequency | $\mathrm{f}_{\text {CRSTL }}$ | 6 | - | 14 | MHz | Fundamental mode, series <br> resonance | 4.25 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

## ASK/FSK SIGNAL SWITCH - Signal MSEL (PIN 14)

| ASK Mode | $\mathrm{V}_{\text {MSEL }}$ | 1.4 | - | $4^{1)}$ | V | Or open |  | 4.26 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| FSK Mode | $\mathrm{V}_{\text {MSEL }}$ | 0 | - | 0.2 | V |  | 4.27 |  |

## FSK DEMODULATOR

| Demodulation Gain | $\mathrm{G}_{\text {FMDEM }}$ | - | 200 | - | $\mu \mathrm{V} /$ <br> kHz |  | 4.28 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Useable IF Bandwidth | $\mathrm{BW}_{\text {IFPLL }}$ | 10.2 | 10.7 | 11.2 | MHz |  | 4.29 |

## POWER DOWN MODE - Signal PDWN (PIN 27)

| Power Mode On | ON | 2.8 | - | $\mathrm{V}_{\mathrm{CC}}$ | V |  |  | 4.30 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Power Mode Standby | Standby | 0 | - | 0.8 | V |  | 4.31 |  |
| Start-up Time until <br> valid signal is <br> detected at IF | $\mathrm{T}_{\text {SU }}$ | - | $<1$ | - | ms | Depends on the used <br> crystal | 4.32 |  |

VCO MULTIPLEXER - Signal FSEL (PIN 9)

| $\mathrm{f}_{\mathrm{RF}}$ range 434 MHz | $\mathrm{V}_{\text {FSEL }}$ | 1.4 | - | $4^{1)}$ | V | Or open |  | 4.33 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{f}_{\mathrm{RF}}$ range 868 MHz | $\mathrm{V}_{\text {FSEL }}$ | 0 | - | 0.2 | V |  | 4.34 |  |

## Electrical Characteristics

Table 11 AC/DC Characteristics with $T_{A M B}=-40^{\circ} \mathrm{C} \ldots+85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=4.5 \ldots 5.5 \mathrm{~V}$ (cont'd)

| Parameter | Symbol | Values |  |  | Unit | Note / Test Condition | Test | Number |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | Min. | Typ. | Max. |  |  |  |  |
| Output bias current | $\mathrm{I}_{\text {FSEL }}$ | -110 | -200 | -340 | $\mu \mathrm{~A}$ | FSEL tied to GND | 4.35 |  |

PLL DIVIDER - Signal CSEL (PIN 15)

| $\mathrm{f}_{\mathrm{CRSTL}}$ range 6.xxMHz | $\mathrm{V}_{\mathrm{CSEL}}$ | 1.4 | - | $4^{1)}$ | V | Or open | 4.36 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{f}_{\mathrm{CRSTL}}$ range <br> $13 . x \mathrm{MHz}$ | $\mathrm{V}_{\mathrm{CSEL}}$ | 0 | - | 0.2 | V |  | 4.37 |
| Input bias current <br> CSEL | $\mathrm{I}_{\text {CSEL }}$ | -3 | -5 | -7 | $\mu \mathrm{~A}$ | CSEL tied to GND | 4.38 |

1) Maximum voltage in Power-On state is 4 V , but in PDWN-state the maximum voltage is 2.8 V .

## Attention: Test ■ means that the parameter is not subject to production test.

It was verified by design/characterization.

### 4.2 Customer Test Circuit

The device performance parameters marked with ■ in Table 9, Table 10, and Table 11 are not subject to production test. They were verified by design/characterization. The received signal is accessible on a 2-pole pin connector and can be used for simple remote-control applications. More information on the board is available on request.


Figure 17 Schematic of the Customer Test Board TDA7210V

### 4.3 Customer Test Board Layout



Figure 18 Top Layer of Customer Test Board TDA7210V


Figure 19 Bottom Layer of Customer Test Board TDA7210V

### 4.4 Bill of Materials

The following components are necessary for evaluation of the TDA7210V.
Table 12 Bill of Materials

| Ref | Value | Specification |
| :---: | :---: | :---: |
| R1 | $100 \mathrm{k} \Omega$ | 0402, $\pm 5 \%$ |
| R2 | $100 \mathrm{k} \Omega$ | 0402, $\pm 5 \%$ |
| R3 | $820 \mathrm{k} \Omega$ | 0402, $\pm 5 \%$ |
| R4 | $240 \mathrm{k} \Omega$ | 0402, $\pm 5 \%$ |
| R5 | $360 \mathrm{k} \Omega$ | 0402, $\pm 5 \%$ |
| R6 | $10 \mathrm{k} \Omega$ | 0402, $\pm 5 \%$ |
| R7 | $\begin{aligned} & 434 \mathrm{MHz}:- \\ & 868 \mathrm{MHz}: 0 \Omega \end{aligned}$ | $0402, \pm 5 \%$ |
| R8 | - | - |
| R9 | $0 \Omega$ | 0402, $\pm 5 \%$ |
| L1 | $\begin{aligned} & 434 \mathrm{MHz}: 30 \mathrm{nH} \\ & 868 \mathrm{MHz}: 8.2 \mathrm{nH} \end{aligned}$ | Coilcraft SIMID 0402HP, $\pm 2 \%$ Coilcraft SIMID 0402HP, $\pm 2 \%$ |
| L2 | $434 \mathrm{MHz}: 56 \mathrm{nH}$ $868 \mathrm{MHz}: 15 \mathrm{nH}$ | Coilcraft SIMID 0402HP, $\pm 2 \%$ Coilcraft SIMID 0402HP, $\pm 2 \%$ |
| C1 | $434 \mathrm{MHz}: 1.8 \mathrm{pF}$ $868 \mathrm{MHz}: 1.2 \mathrm{pF}$ | $\begin{aligned} & \text { 0402, COG, } \pm 0.1 \mathrm{pF} \\ & \text { 0402, COG, } \pm 0.1 \mathrm{pF} \end{aligned}$ |
| C2 | $\begin{aligned} & 434 \mathrm{MHz}:- \\ & 868 \mathrm{MHz}:- \end{aligned}$ | $0402, \mathrm{COG}, \pm 0.1 \mathrm{pF}$ |
| C3 | $434 \mathrm{MHz}: 18 \mathrm{pF}$ $868 \mathrm{MHz}: 10 \mathrm{pF}$ | $\begin{aligned} & \text { 0402, COG, } \pm 0.1 \mathrm{pF} \\ & 0402, \mathrm{COG}, \pm 0.1 \mathrm{pF} \end{aligned}$ |
| C4 | 100 pF | 0402, COG, $\pm 5 \%$ |
| C5 | 47 nF | 0402, COG, $\pm 5 \%$ |
| C6 | $\begin{aligned} & 434 \mathrm{MHz}: ~-~ \\ & 868 \mathrm{MHz} \text { - } \end{aligned}$ |  |
| C7 | 100 pF | 0402, X7R, $\pm 5 \%$ |
| C8 | $434 \mathrm{MHz}: 100 \mathrm{pF}$ $868 \mathrm{MHz}: 270$ pF | $\begin{aligned} & \text { 0402, COG, } \pm 1 \% \\ & 0402, \text { COG, } \pm 1 \% \end{aligned}$ |
| C9 | 100 pF | 0402, COG, $\pm 5 \%$ |
| C10 | 10 nF | 0402, X7R, $\pm$ 10\% |
| C11 | 10 nF | 0402, X7R, $\pm$ 10\% |
| C12 | 220 pF | 0402, COG, $\pm 5 \%$ |
| C13 | 47 nF | 0402, X7R, $\pm$ 10\% |
| C14 | 470 pF | 0402, COG, $\pm 5 \%$ |
| C15 | 47 nF | 0402, X7R, $\pm 5 \%$ |
| C16 | 8.2 pF | 0402, COG, $\pm 0.1 \mathrm{pF}$ |
| C17 | 22 pF | 0402, COG, $\pm 1 \%$ |
| C18 | 22 nF | 0402, X7R, $\pm 5 \%$ |

Table 12 Bill of Materials (cont'd)

| Ref | Value | Specification |
| :--- | :--- | :--- |
| C19 | 10 nF | $0402, \mathrm{X} 7 \mathrm{R}, \pm 5 \%$ |
| C 20 | 47 nF | $0402, \mathrm{X} 7 \mathrm{R}, \pm 5 \%$ |
| C 21 | $2.2 \mu \mathrm{~F}$ | $0805, \mathrm{X} 7 \mathrm{R}, \pm 10 \%$ |
| C 22 | 47 nF | $0402, \mathrm{X} 7 \mathrm{R}, \pm 5 \%$ |
| Q1 | $\left(\mathrm{f}_{\mathrm{RF}}-10.7 \mathrm{MHz}\right) / 32$ or <br> $\left(\mathrm{f}_{\mathrm{RF}}-10.7 \mathrm{MHz}\right) / 64$ | Tokoy Denpa TSS-6035B <br> $434 \mathrm{MHz}: 13.2343750 \mathrm{MHz}, \mathrm{CL}=12 \mathrm{pF}$, Spec.No. 120-16504 <br> $868 \mathrm{MHz}: 13.4015625 \mathrm{MHz}, \mathrm{CL}=12 \mathrm{pF}$, Spec.No. 120-16505 |
| Q2 | IF-Filter 10,7MHz | Murata SFECF10M7FA00S0-R0 |
| X1, X3 | 2-pole pin connector | 2-pole pin connector, 2,54mm |
| X2 | SMA-connector | RS: SMA Jack End Launch 1,07mm |
| JP1 | 3-pole pin connector | 3-pole pin connector, 2,54mm |
| MSEL | solder bridge | closed solder bridge |
| CSEL | solder bridge | closed solder bridge |
| IC1 | TDA7210V | Infineon |

ww w.infineon.com


[^0]:    1) Note the $20 \mathrm{k} \Omega$ resistor in series with the 3.1 V internal voltage source
[^1]:    1) Taken from Tietze/Schenk: Halbleiterschaltungstechnik, Springer Berlin, 1999.
